## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant:

Suan J. Boon

Title:

METHOD OF PACKAGING AT A WAFER LEVEL

Docket No.:

303.601US3

Serial No.: 10/722,838

Filed:

November 26, 2003

Due Date: July 6, 2007

Examiner:

James M. Mitchell

Group Art Unit: 2813

## MS Amendment

Commissioner for Patents

P.O. Box 1450

Alexandria, VA 22313-1450

We are transmitting herewith the following attached items (as indicated with an "X"):

 $\underline{X}$  Amendment and Response (14 pgs.).

If not provided for in a separate paper filed herewith, Please consider this a PETITION FOR EXTENSION OF TIME for sufficient number of months to enter these papers and please charge any additional fees or credit overpayment to Deposit Account No. 19-0743.

SCHWEGMAN, LUNDBERG, WOESSNER & KLUTH, P.A.

Customer Number 21186

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Reg. No. 46,632

CERTIFICATE UNDER 37 CFR 1.8: The undersigned hereby certifies that this correspondence is being filed using the USPTO's electronic filing system EFS-Web, and is addressed to: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on

this 5 day of July, 2007.

Name

Signature

SCHWEGMAN, LUNDBERG, WOESSNER & KLUTH, P.A.

(GENERAL)